RL78/G23

Handshake-based SPI Slave Transmission/Reception

Introduction

This application note describes how the serial array unit (SAU) performs slave transmission/reception by the simple SPI (CSI). The slave selected by the chip select (CS) signal performs single transmission/reception, single transmission, or single reception according to the processing. The SAU also performs handshake processing using the BUSY signal.

Target Device

RL78/G23

When applying the sample program covered in this application note to another microcomputer, modify the program according to the specifications for the target microcomputer and conduct an extensive evaluation of the modified program.
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1. Specifications

The serial array unit (SAU) described in this application note performs CSI slave communication. A slave is selected by the chip select (CS) signal from the master. The SAU performs handshake processing using the BUSY signal and performs slave communication.

1.1 Outline of CSI Communication

CSI communication is clock-synchronous serial communication using three signal lines, namely, serial clock (SCK), serial data input (SI), and serial data output (SO). SPI (Serial Peripheral Interface) uses an additional chip select (CS) signal to select the slave device. The relationship among these signals is shown in Figure 1-1.

![Figure 1-1 Outline of CSI Communication](image)

<table>
<thead>
<tr>
<th>Simple SPI (CSI) signals</th>
<th>Additional signal for SPI</th>
<th>BUSY signals</th>
</tr>
</thead>
<tbody>
<tr>
<td>SCK signal</td>
<td>Serial clock signal. Output by the master.</td>
<td></td>
</tr>
<tr>
<td>SO signal</td>
<td>Serial data output signal Connected to the SI signal pin of the target device.</td>
<td></td>
</tr>
<tr>
<td>SI signal</td>
<td>Serial data input signal. Connected to the SO signal pin of the target device.</td>
<td></td>
</tr>
<tr>
<td>CS signal</td>
<td>Used by the master device to select the target slave device.</td>
<td></td>
</tr>
<tr>
<td>BUSY signal</td>
<td>Handshake signal used in this application note.</td>
<td></td>
</tr>
</tbody>
</table>

Slaves wait until they are selected by the CS signal. When a slave is selected by the CS signal, that slave synchronizes with the SCK signal output from the master, outputs data to the SO signal line, and inputs data from the SI signal line.

In SPI/CSI communication, the slave needs to become ready for communication by the time the master starts communication (sending the SCK signals). In this application note, the slave notifies the master that it is ready for communication by setting the BUSY signal low.
1.2 Outline of Communication

In this application note, a command and communication for the command are performed at intervals of 1 ms. A set of a command and communication for the command is defined as a slot. Figure 1-2 shows an outline of slot processing and Table 1-1 lists the commands to be used.

![Figure 1-2 Outline of Slots](image)

Table 1-1 Commands to be Used

<table>
<thead>
<tr>
<th>Command</th>
<th>Outline of Operation</th>
</tr>
</thead>
<tbody>
<tr>
<td>Status check</td>
<td>Checks the number of data characters that the slave can transmit or receive.</td>
</tr>
<tr>
<td>Receive</td>
<td>Receives data from the slave.</td>
</tr>
<tr>
<td>Transmit</td>
<td>Transmits data to the slave.</td>
</tr>
<tr>
<td>Transmit/receive</td>
<td>Transmits and receives data to and from the slave.</td>
</tr>
</tbody>
</table>

Table 1-2 lists the peripheral functions and their uses. Figure 1-3 and Figure 1-4 show the CSI communication operations.

Table 1-2 Peripheral Functions and Their Uses

<table>
<thead>
<tr>
<th>Peripheral Function</th>
<th>Use</th>
</tr>
</thead>
<tbody>
<tr>
<td>Serial array unit 0</td>
<td>Performs CSI slave communication using the SCK00 signal (clock output), SI00 signal (receive data), and SO00 signal (transmit data).</td>
</tr>
<tr>
<td>Port</td>
<td>Uses P00 to output the BUSY signal.</td>
</tr>
<tr>
<td>External interrupt</td>
<td>Uses INTP0/P137 to detect the CS signal.</td>
</tr>
</tbody>
</table>
Figure 1-3 Timing chart for status check commands

Figure 1-4 Timing chart of commands sent and received
1.3 Communication Format

Table 1-3 lists the characteristics of the CSI communication format that is used in the sample code.

**Table 1-3 Communication Format**

<table>
<thead>
<tr>
<th>Item</th>
<th>Specification</th>
<th>Remarks</th>
</tr>
</thead>
<tbody>
<tr>
<td>Communication speed</td>
<td>1 Mbps</td>
<td>About 200 kbps at minimum</td>
</tr>
<tr>
<td>Data bit length</td>
<td>8 bits/character</td>
<td></td>
</tr>
<tr>
<td>Transfer order</td>
<td>MSB first</td>
<td></td>
</tr>
<tr>
<td>Communication type</td>
<td>Type 1</td>
<td></td>
</tr>
<tr>
<td>Communication mode</td>
<td>Single transfer</td>
<td></td>
</tr>
<tr>
<td>Communication direction</td>
<td>Receive/transmit/transmit and receive</td>
<td></td>
</tr>
<tr>
<td>Maximum number of characters transferred</td>
<td>63 characters/slot</td>
<td>8 characters by default</td>
</tr>
</tbody>
</table>

1.4 Handshake

Generally, SPI communication-dedicated slave devices, such as EEPROM, are always communication-ready and therefore do not require the BUSY signal. However, when using a general-purpose device, such as an MCU, to perform slave communication, processing time required by the software must be secured. In this application note, handshaking is performed using the BUSY signal so that SPI communication can be established even when the load exceeds the processing capability of a general-purpose device. Additionally, a timeout of 16 μs is set up so that the system does not stop even when no response using the BUSY signal is returned.

Figure 1-1 shows an example of handshaking for status checking. The slave selected by the CS signal sets the BUSY signal low after completing the preparation of slave communication. The slave sets the BUSY signal high when the command reception from the master is completed. Then, the slave sets the BUSY signal low again after completing the preparation of slave communication according to the command.
1.5 Specification Details

This sample code, after completion of initialization, transitions to standby mode. The slave selected by the CS signal sets the BUSY signal low after completing the preparation of communication. The slave sets the BUSY signal high when the command reception from the master is completed. After communication is completed, the slave sets the BUSY signal high and prepares for the next communication. While the slave is selected by the CS signal, it controls data transmission/reception and the BUSY signal.

(1) Initialize the port.
   <Conditions for setting the port>
   ● Use P00 controlling the BUSY signal in N-ch open drain output mode.
   ● Use P137/INTP0 detecting the CS signal as an input port.

(2) Initialize the external interrupt function.
   <Conditions for setting external interrupt>
   ● Use INTP0 for both edges.
   ● Set the priority of INTP0 to the lowest level (3, by default).

(3) Initialize the CSI.
   <Conditions for setting the CSI>
   ● Use SAU0 channel 0 as CSI00.
   ● Use the external clock as the transfer clock.
   ● Assign the clock input to the P10/SCK00 pin, the data input to the P11/SI00 pin, and the data output to the P12/SO00 pin.
   ● Use single transfer mode as the transfer mode.
   ● Set the data length to 8 bits.
   ● Set the phase between the data and clock to type 1.
   ● Set the order of data transfer mode to MSB first.
   ● Use transmission end and reception end interrupts as the interrupt (INTCSI00).
   ● Set the priority of the interrupt (INTCSI00) to the lowest level (3, by default).
(4) After initialization is completed, the slave performs communication as shown in the following steps.

① The slave waits in standby state (HALT mode) until it is selected by the $CS$ signal.

② An external interrupt INTP0 occurs by the falling edge of the $CS$ signal, and the slave is released from HALT mode.

③ The slave enables CSI00 for operation, enables SO00 for output, sets the BUSY signal low, and waits for the start of command reception processing.

④ The slave separates the receive data into the upper 2 bits containing the command from the master, and the remaining lower 6 bits.

⑤ The slave branches into the master command processing, status check, data reception, transmission, or transmission/reception.

⑥ The slaves executes the processing specified by the command.

⑦ After the processing is completed, the slave waits in standby state (HALT mode) until the $CS$ signal goes high.

⑧ An external interrupt INTP0 occurs by the rising edge of the $CS$ signal, and the slave is released from HALT mode. After confirming that the $CS$ signal is high, disable CSI00 for operation and disable SO00 for output. These steps are subsequently repeated from step 1.

(5) Command reception

Each communication operation begins with the reception of a 1-byte command. Table 1-4 lists the command formats.

### Table 1-4 Command Formats

<table>
<thead>
<tr>
<th>Command Code</th>
<th>Command Outline</th>
</tr>
</thead>
<tbody>
<tr>
<td>Status check</td>
<td>Checks the number of data characters that the slave can transmit or receive. The following responses can be made by the slave: 01xxxxxB: The number of characters that the slave can transmit is xxxxxB. 00xxxxxB: The number of characters that the slave can receive is xxxxxB.</td>
</tr>
<tr>
<td>Reception</td>
<td>The master receives xxxxxB bytes of data.</td>
</tr>
<tr>
<td>Transmission</td>
<td>The master transmits xxxxxB bytes of data.</td>
</tr>
<tr>
<td>Transmission/reception</td>
<td>The master transmits and receives xxxxxB bytes of data.</td>
</tr>
</tbody>
</table>
2. Operation Confirmation Conditions

The operation of the sample code provided with this application note has been tested under the following conditions.

Table 2-1 Operation Confirmation Conditions

<table>
<thead>
<tr>
<th>Item Description</th>
<th>Item Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>MCU used</td>
<td>RL78/G23 (R7F100GLG)</td>
</tr>
<tr>
<td>Operating frequency</td>
<td></td>
</tr>
<tr>
<td></td>
<td>High-speed on-chip oscillator clock (fIH): 32 MHz</td>
</tr>
<tr>
<td></td>
<td>CPU/peripheral hardware clock: 32 MHz</td>
</tr>
<tr>
<td>Operating voltage</td>
<td></td>
</tr>
<tr>
<td></td>
<td>During VDD operation: 5.0 V (4.0V~5.5V)</td>
</tr>
<tr>
<td></td>
<td>LVD0 detection voltage: Reset mode</td>
</tr>
<tr>
<td></td>
<td>At rising edge TYP. 1.90 V (1.84 V to 1.95 V)</td>
</tr>
<tr>
<td></td>
<td>At falling edge TYP. 1.86 V (1.80 V to 1.91 V)</td>
</tr>
<tr>
<td>Integrated development environment (CS+)</td>
<td>CS+ V8.08.00 from Renesas Electronics Corp.</td>
</tr>
<tr>
<td>C compiler (CS+)</td>
<td>CC-RL V1.11.00 from Renesas Electronics Corp</td>
</tr>
<tr>
<td>Integrated development environment (e2studio)</td>
<td>e2 studio V2022-07 (22.7.0) from Renesas Electronics Corp</td>
</tr>
<tr>
<td>C compiler (e2studio)</td>
<td>CC-RL V1.11.00 from Renesas Electronics Corp</td>
</tr>
<tr>
<td>Integrated development environment (IAR)</td>
<td>IAR Embedded Workbench for Renesas RL78 V4.21.2 from IAR Systems Corp</td>
</tr>
<tr>
<td>C compiler (IAR)</td>
<td>IAR C/C++ Compiler for Renesas RL78 V4.21.2.2420 from IAR Systems Corp</td>
</tr>
<tr>
<td>Smart Configurator</td>
<td>V.1.4.0</td>
</tr>
<tr>
<td>Board Support Package (r_bsp)</td>
<td>V.1.30</td>
</tr>
<tr>
<td>Board used</td>
<td>RL78/G23 Fast Prototyping Board (RTK7RLG230CLG000BJ)</td>
</tr>
</tbody>
</table>

3. Related Application Notes

See also the following application notes, which are related to this application note:

RL78/G23 Handshake-based SPI Master Transmission/Reception (R01AN5889J) APPLICATION NOTE
4. Hardware Descriptions

4.1 Example of Hardware Configuration

Figure 4-1 shows an example of the hardware configuration used in the application note.

Figure 4-1 Hardware Configuration

Note 1. This schematic circuit diagram is simplified to show the outline of connections. When creating circuits, design them so that they meet electrical characteristics by properly performing pin processing. (Connect input-only ports to VDD or VSS individually through a resistor.)

Note 2. Connect pins (with a name beginning with EVSS), if any, to VSS, and connect pins (with a name beginning with EVDD), if any, to VDD.
4.2 List of Pins to be Used

Table 4-1 lists the pins to be used and their functions.

### Table 4-1 Pins to be Used and Their Functions

<table>
<thead>
<tr>
<th>Pin Name</th>
<th>I/O</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>P10/EI10/EO10/SCK00/SCL00/(TI07)/(TO07)</td>
<td>Output</td>
<td>Serial clock output pin</td>
</tr>
<tr>
<td>P11/EI11/EO11/SI00/RxD0/TOOLRxD/SDA00/(TI06)/(TO06)</td>
<td>Input</td>
<td>Data reception pin</td>
</tr>
<tr>
<td>P12/EI12/EO12/SO00/TxD0/TOOLTxD/(INTP5)/(TI05)/(TO05)</td>
<td>Output</td>
<td>Data transmission pin</td>
</tr>
<tr>
<td>P00/TS26/EI00/TI00</td>
<td>Output</td>
<td>BUSY signal output to the master</td>
</tr>
<tr>
<td>P137/EI137/INTP0</td>
<td>Input</td>
<td>CS signal detection</td>
</tr>
</tbody>
</table>

Caution In this application note, only the used pins are processed. When actually designing your circuit, make sure the design includes sufficient pin processing and meets electrical characteristic requirements.
5. Description of the Software

5.1 List of Option Byte Settings

Table 5-1 summarizes the settings of the option bytes.

Table 5-1 Option Byte Settings

<table>
<thead>
<tr>
<th>Address</th>
<th>Setting Value</th>
<th>Contents</th>
</tr>
</thead>
<tbody>
<tr>
<td>000C0H</td>
<td>1110 1111B (EFH)</td>
<td>Stops the watchdog timer operation. (Stops counting after the release of the reset state.)</td>
</tr>
<tr>
<td>000C1H</td>
<td>1111 1110B (FEH)</td>
<td>LVD reset mode Detection Voltage: On the rising edge: TYP. 1.90V (1.84 V to 1.95 V) On the falling edge: TYP. 1.86V (1.80 V to 1.91 V)</td>
</tr>
<tr>
<td>000C2H</td>
<td>11101000B (E8H)</td>
<td>HS mode, HOCO: 32 MHz</td>
</tr>
<tr>
<td>000C3H</td>
<td>10001000B (84H)</td>
<td>Enables the on-chip debugging function.</td>
</tr>
</tbody>
</table>

5.2 List of Constants

Table 5-2 lists the constants that are used in the sample code.

Table 5-2 Constants Used in the Sample Code

<table>
<thead>
<tr>
<th>Constant Name</th>
<th>Definition location</th>
<th>Setting Value</th>
<th>Contents</th>
</tr>
</thead>
<tbody>
<tr>
<td>CS_pin</td>
<td>r_cg_userdefine.h</td>
<td>P13.bit.no7</td>
<td>Port register for the CS signal</td>
</tr>
<tr>
<td>PM_SO00</td>
<td>r_cg_userdefine.h</td>
<td>PM1.bit.no2</td>
<td>Port mode register for the SO00 signal</td>
</tr>
<tr>
<td>PM_BUSY</td>
<td>r_cg_userdefine.h</td>
<td>PM0.bit.no0</td>
<td>Port mode register for the BUSY signal</td>
</tr>
<tr>
<td>BUSYOUT</td>
<td>r_cg_userdefine.h</td>
<td>P0.bit.no0</td>
<td>Port register for the BUSY signal</td>
</tr>
<tr>
<td>TX_NUM</td>
<td>main.c</td>
<td>32</td>
<td>Number of data characters that can be transmitted</td>
</tr>
<tr>
<td>RX_NUM</td>
<td>main.c</td>
<td>32</td>
<td>Number of data characters that can be received</td>
</tr>
<tr>
<td>data_length</td>
<td>main.c</td>
<td>1</td>
<td>Data length</td>
</tr>
<tr>
<td>TX_DATA[]</td>
<td>main.c</td>
<td>*1</td>
<td>Stores 63 characters of transmit data, the maximum number of characters transferred.</td>
</tr>
</tbody>
</table>

Note: 1. In this application note, ASCII codes from 0x40 to 0x7F are stored.

5.3 List of Variables

Table 5-3 lists the global variables that are used in this sample code.

Table 5-3 Global Variables Used in the Sample Code

<table>
<thead>
<tr>
<th>Type</th>
<th>Variable Name</th>
<th>Contents</th>
<th>Function Used</th>
</tr>
</thead>
<tbody>
<tr>
<td>uint8_t</td>
<td>g_tx_data</td>
<td>Buffer for transmit data</td>
<td>main.c</td>
</tr>
<tr>
<td>uint8_t</td>
<td>g_rx_data</td>
<td>Buffer for receive data</td>
<td>main.c</td>
</tr>
<tr>
<td>uint8_t</td>
<td>g_mode_check</td>
<td>Mode check flag</td>
<td>main.c</td>
</tr>
<tr>
<td>uint8_t</td>
<td>g_num</td>
<td>Number of characters to be transmitted/received requested by the master</td>
<td>main.c</td>
</tr>
<tr>
<td>uint8_t</td>
<td>g_rx_data_stored[]</td>
<td>Stores receive data.</td>
<td>main.c</td>
</tr>
</tbody>
</table>
5.4 List of Functions

Table 5-4 lists the functions that are used in the sample code.

Table 5-4 Functions

<table>
<thead>
<tr>
<th>Function Name</th>
<th>Outline</th>
<th>Source file</th>
</tr>
</thead>
<tbody>
<tr>
<td>main</td>
<td>Main processing</td>
<td>main.c</td>
</tr>
<tr>
<td>CSI00_Status_check</td>
<td>CSI status check</td>
<td>main.c</td>
</tr>
<tr>
<td>CSI00_Send_Receive</td>
<td>CSI transmission/reception</td>
<td>main.c</td>
</tr>
<tr>
<td>CSI00_Send</td>
<td>CSI transmission (master receives data)</td>
<td>main.c</td>
</tr>
<tr>
<td>CSI00_Receive</td>
<td>CSI reception (master transmits data)</td>
<td>main.c</td>
</tr>
<tr>
<td>r_Config_CSI00_callback_ihsend</td>
<td>Setting BUSY signal high</td>
<td>Config_CSI00_user.c</td>
</tr>
</tbody>
</table>

5.5 Function Specifications

The following tables list the sample code function specifications.

[Function Name] main

<table>
<thead>
<tr>
<th>Synopsis</th>
<th>Main processing</th>
</tr>
</thead>
<tbody>
<tr>
<td>Header</td>
<td>r_smc_entry.h</td>
</tr>
<tr>
<td>Declaration</td>
<td>void main(void)</td>
</tr>
<tr>
<td>Explanation</td>
<td>Starts the operation of INTP0.</td>
</tr>
<tr>
<td></td>
<td>Starts CSI communication and receives a command from the master when INTP0 occurs.</td>
</tr>
<tr>
<td></td>
<td>Branch into the processing corresponding to the received command.</td>
</tr>
<tr>
<td>Arguments</td>
<td>• None</td>
</tr>
<tr>
<td>Return value</td>
<td>• None</td>
</tr>
<tr>
<td>Remarks</td>
<td>None</td>
</tr>
</tbody>
</table>

[Function Name] CSI00_Status_check

<table>
<thead>
<tr>
<th>Synopsis</th>
<th>CSI status check</th>
</tr>
</thead>
<tbody>
<tr>
<td>Header</td>
<td>r_smc_entry.h</td>
</tr>
<tr>
<td>Declaration</td>
<td>void CSI00_Status_check (void)</td>
</tr>
<tr>
<td>Explanation</td>
<td>Checks the status of the slave.</td>
</tr>
<tr>
<td>Arguments</td>
<td>• None</td>
</tr>
<tr>
<td>Return value</td>
<td>• None</td>
</tr>
<tr>
<td>Remarks</td>
<td>None</td>
</tr>
</tbody>
</table>
### CSI00_Send_Receive

**Synopsis**
CSI transmission/reception

**Header**
r_smc_entry.h

**Declaration**
void CSI00_Send_Receive (void)

**Explanation**
Performs the slave transmission/reception processing.

**Arguments**
- None

**Return value**
- None

**Remarks**
None

### CSI00_Send

**Synopsis**
CSI transmission

**Header**
r_smc_entry.h

**Declaration**
void CSI00_Send (void)

**Explanation**
Performs the slave transmission processing.

**Arguments**
- None

**Return value**
- None

**Remarks**
None

### CSI00_Receive

**Synopsis**
CSI reception

**Header**
r_smc_entry.h

**Declaration**
void CSI00_Receive (void)

**Explanation**
Performs the slave reception processing.

**Arguments**
- None

**Return value**
- None

**Remarks**
None

### r_Config_CSI00_callback_sendend

**Synopsis**
Setting BUSY signal high

**Header**
r_cg_macrodriver.h
r_cg_userdefine.h
Config_CSI00.h

**Declaration**
static void r_Config_CSI00_callback_sendend(void)

**Explanation**
Sets the BUSY signal high.

**Arguments**
- None

**Return value**
- None

**Remarks**
None
5.6 Flowcharts

5.6.1 Flowchart of Main Processing

Figure 5-1 to Figure 5-2 show the overall flow of processing in this application note.

**Figure 5-1 Main Processing 1/2**

```
main()

- Initialize buffer for transmit/receive data
- g_tx_data ← 0xff
- g_rx_data ← 0xff

- Set the SO00 and BUSY signals as input ports
  - PM_SO00 ← 1U
  - PM_BUSY ← 1U

- Start detecting pin input edge (INTP0)
  - R_Config_INTC_INTP0_Start()

- Disable interrupts
  - IE ← 0U

- Enter HALT mode

- Clear INTP0 interrupt request flag

- CS_pin == 0U
  - Yes
  - Set the SO00 and BUSY signals as output ports
    - PM_SO00 ← 0U
    - PM_BUSY ← 0U

  - CS00 start setup

  - Enable interrupts
    - IE ← 1U

  - Make CS00 transmit/receive data
    - R_Config_CS00_Send_Receive(g_tx_data, data_length, &g_rx_data)

  - Set BUSY signal low
  - BUSYOUT ← 0U

  - Enter HALT mode

- INTCSI00 occurred

- A

- INTP0 occurred

- B

```
Figure 5-2 Main Processing 2/2

- Save receive data
- Analyze receive data
- g_mode_check
- CSI status check: CSI00_Status_check()
- CSI transmission (master receives data): CSI00_Send()
- CSI reception (master transmits data): CSI00_Receive()
- CSI transmission/reception: CSI00_Send_Receive()

Data:
- 0x00
- 0x40
- 0x80
- 0xc0
- Others
5.6.2 Flowchart of CSI Status Check

Figure 5-3 shows the flow of CSI status checking.

**Figure 5-3 CSI Status Check**

```
CSI00_Status_check()

cnt = 0

cnt <= 1
  Yes
  cnt == 0
    Set slave transmittable data count in buffer for transmit data
    Make CSI00 transmit/receive data  
    R_Config_CSI00_Send_Receive(&g_tx_data, data_length, &g_rx_data)
  No
  cnt ++

Set BUSY signal low

Enter HALT mode

INTCSI00 occurred

cnt ++

Return
```

- **cnt = 0**
- **cnt <= 1**
- **cnt == 0**
- **cnt ++**
- **Return**
5.6.3 Flowchart of CSI Transmission/Reception

Figure 5-4 shows the flow of CSI transmission and reception.

**Figure 5-4 CSI Transmission/Reception**

- **CSI00_Send_Receive()**
  - cnt = 0

- cnt <= g_num
  - Yes: Set buffer for transmit data
  - No: BUSYOUT ← 0U

- Make CSI00 transmit/receive data
  - R_Config_CSI00_Send_Receive(&g_tx_data, data_length, &g_rx_data)

- Set BUSY signal low
  - Enter HALT mode

- Save receive data
  - cnt ++

- Return

INTCSI00 occurred
5.6.4 Flowchart of CSI Transmission
Figure 5-5 shows the flow of CSI transmission.

**Figure 5-5 CSI Transmission**

```plaintext
CSI00_Send()

cnt = 0

cnt <= g_num

Yes

Set buffer for transmit data

R_Config_CSI00_Send_Receive(&g_tx_data, data_length, &g_rx_data)

No

Set BUSY signal low

BUSYOUT ← 0U

Enter HALT mode

INTCSI00 occurred

cnt ++

Return
```
5.6.5 Flowchart of CSI Reception

Figure 5-6 shows the flow of CSI reception.

**Figure 5-6 CSI Reception**

![Flowchart of CSI Reception](image)

- **CSI00_Receive()**
  - cnt = 0
  - Set dummy data in buffer for transmit data: g\_tx\_data ← 0xff
  - cnt <= g\_num
    - Yes
      - R\_Config\_CSI00\_Send\_Receive(&g\_tx\_data, data_length, &g\_rx\_data)
    - No
      - Set BUSY signal low: BUSYOUT ← 0U
      - Enter HALT mode
      - Save receive data
      - cnt ++
  - INTCSI00 occurred
- Return
5.6.6 Flowchart of Setting BUSY Signal High

Figure 5-7 shows the flow of setting the BUSY signal high.

**Figure 5-7 Setting BUSY Signal High**

```
r_Config_CSI00_callback_sendend()

Set BUSY signal high  BUSYOUT ← 1U

Return
```
6. **Sample Code**

Sample code can be downloaded from the Renesas Electronics website.

7. **Reference Documents**

RL78/G23 User's Manual: Hardware (R01UH0896)
RL78 family user's manual software (R01US0015)
The latest versions can be downloaded from the Renesas Electronics website.

Technical update
The latest versions can be downloaded from the Renesas Electronics website.

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### Revision History

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General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)
   A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on
   The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state
   Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins
   Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals
   After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin
   Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between $V_{IL}$ (Max.) and $V_{IH}$ (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between $V_{IL}$ (Max.) and $V_{IH}$ (Min.).

7. Prohibition of access to reserved addresses
   Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products
   Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.
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